IPC ASSOCIATION CONNI ELECTRONICS INDUS	© Copyright 2005. IPC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both nternational and Pan-American copyright conventions.		This docu			es within the manufactur wer level materials for w				
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information						
upplier Info	Cormation										
Company name* Company unique ID			nique ID		Unique ID Authority			Response Date*			
nsemi								2024-04-20			
ontact Name		Title - Conta	act	Phor		Phone - Contact*			Email - Contact*		
Product-Env-Stewards Product-Env-Stewards			Product Enviro Compliance		NA	NA			Product-Env-Stewards@onsemi.com		
Authorized Representative* Title - Represe			esentative	ntative Phone		ne - Representative*		Email - Representative*			
Product-Env-Stewards Product Enviro Complianc			viro Compliance		NA Product-Env-Stewards@onsemi.com				om		
Requ	Requester Item Number Mfr Item		Number Mfr Item Name		Effective Date	Version	Manufacturing Site	Weight*	UOM	Unit Type	
		NXH006P120MNF2P TG	PIM F2 6mOhm 120 Module	00V Halfbridge SiC	2024-04-20		CNG	44003.234	mg	Each	
lanufacturi	ing Proccess Information	o n									
Term	Terminal Plating / Grid Array Material Term		erminal Base Alloy J-STD-020 MSL		Peak Process Body Temperature Max Time at Pea		ture Max Time at Peak	Temperature Numbe	r of Reflow Cy	cles	
Matte	Matte Tin (Sn) - annealed		CU Alloy NA		0	С	30	seconds 3			

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's St											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per t	he definition above except for defined Rol	IS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Case	19160.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		5748	mg
			Supplier	Poly(ButyleneTerephthalate)	30965-26-5		5364.7998	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		670.6	mg
			Supplier	PBT	26062-94-2		5364.7998	mg
			-	Carbonic Dichloride	94334-64-2		2011.7999	mg
DBC	10960.0	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		4274.3999	mg
			В	Nickel (Ni)	7440-02-0		109.6	mg
			Supplier	Copper (Cu)	7440-50-8		6576.0005	mg
Die	90.415	mg	Supplier	Silicon Carbide	409-21-2		90.415	mg
Glue	210.0	mg	Supplier	2,3-epoxypropyl-trimethoxysilan	2530-83-8		21	mg
			Supplier	Miscellaneous	Trade Secret		21	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		168	mg
Interconnect	830.0	mg	Supplier	Distillate (petroleum), Hydrotreated	64742-47-8		83	mg
			Supplier	Aluminum (Al)	7429-90-5		747	mg
Silicone Gel	5620.0	mg	Supplier	Silica, [(ethenyldimethylsilyl)oxy]- and [(trimethylsilyl)oxy]- modified	68988-89-6		1686.0001	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		3934	mg
Solder Paste	674.0	mg	Supplier	Silver (Ag)	7440-22-4		23.59	mg
			Supplier	Tin (Sn)	7440-31-5		650.41	mg
Terminal	6322.5	mg	Supplier	Silicon (Si)	7440-21-3		17.0708	mg
			В	Nickel (Ni)	7440-02-0		85.3538	mg
			Supplier	Copper (Cu)	7440-50-8		6218.4951	mg
			Supplier	Phosphorus (P)	7723-14-0		1.5806	mg
Thermistor	13.0	mg	Supplier	Tin (Sn)	7440-31-5		0.1625	mg
			Supplier	Nickel Oxide (NiO)	1313-99-1		0.0195	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.0208	mg
			В	Nickel (Ni)	7440-02-0		3.0355	mg
			Supplier	Gold (Au)	7440-57-5		0.0026	mg
			Supplier	Iron (Fe)	7439-89-6		3.25	mg
			A	Lead Oxide (PbO)	1317-36-8		2.9796	mg
			Supplier	Cobalt Oxide (Co3O4)	1308-06-1		0.0195	mg
			Supplier	Manganese Tetraoxide (Mn3O4)	1317-35-7		0.0195	mg

			Supplier	Potassium Monoxide (K2O)	12136-45-7	0.2522	mg
			Supplier	Copper (Cu)	7440-50-8	1.4365	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7	1.8018	mg
Wire Bond - Al	123.318	mg	Supplier	Aluminum (Al)	7429-90-5	123.318	mg